

# New Mission Concept (**MeGaT**): a high precise **MeV Gamma Telescope** using TPC Technique read out with Micromegas

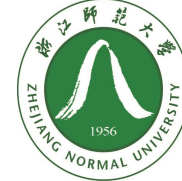
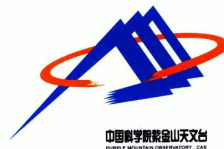
**Ruizhi Yang**

**On behalf of the MeGaT Group**



# MeGaT Group members

YiFu Cai<sup>1,2</sup>, Changqing Feng<sup>1,2</sup>, Jingnan Guo<sup>2</sup>, Leipeng Hu<sup>2</sup>, Kun Jiang<sup>1</sup>, Xiaoshen Kang<sup>4</sup>, Jian Li<sup>1,2</sup>, Nenghui Liao<sup>8</sup>, Xinpeng Li<sup>2</sup>, Bing Liu<sup>2</sup>, Cong Liu<sup>2</sup>, Jianbei Liu<sup>1,2</sup>, Ruoyu Liu<sup>5</sup>, Shubin Liu<sup>1,2</sup>, Chenye Shen<sup>2</sup>, Shaobo Wang<sup>3</sup>, Xuan Wang<sup>4</sup>, Yu Wang<sup>2</sup>, Libo Wu<sup>1</sup>, Hubing Xiao<sup>7</sup>, Lailin Xu<sup>1,2</sup>, Rui Xue<sup>9</sup>, Ruizhi Yang<sup>1,2</sup>, Zhengguang Yang<sup>2</sup>, Qiang Yuan<sup>6</sup>, Yunlong Zhang<sup>2</sup>, Zhiyong Zhang<sup>1,2</sup>, Maoyuan Zhao<sup>2</sup>, Zhengguo Zhao<sup>1,2</sup>, Rui Zhou<sup>2</sup>, Yong Zhou<sup>2</sup>, Zheyang Zhou<sup>2</sup>, Hao Zhuang<sup>2</sup>



# Outline

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## ❑ Introduction on MeV $\gamma$ -ray astronomy

## ❑ MeV $\gamma$ -ray detection

- Key technological challenges
- Some experimental proposals

## ❑ MeGaT experiment & R&D process

- Conceptual design
- Simulation framework and results
- Prototype of R&D
- Electronics

## ❑ Summary

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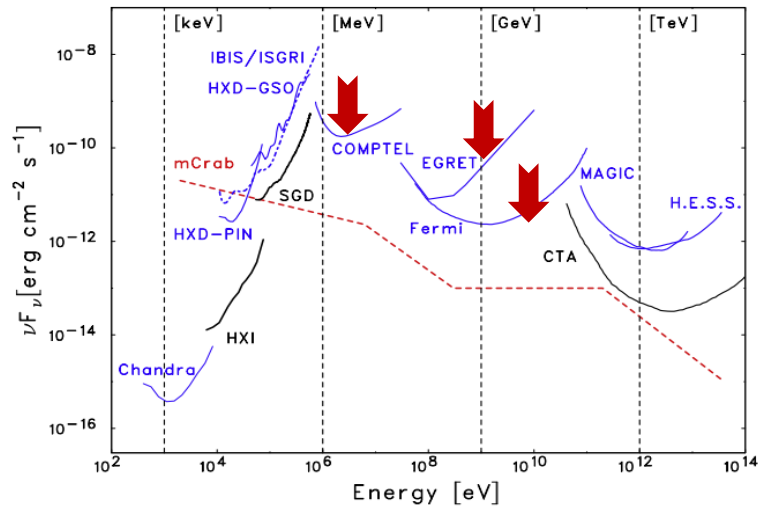
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# MeV $\gamma$ -ray astronomy observations

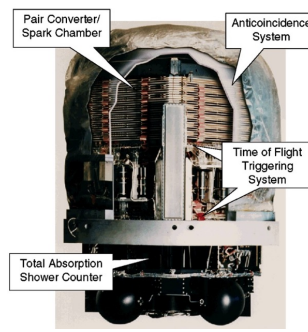
*T. Takahashi et al. / Astroparticle Physics 43 (2013) 142–154*



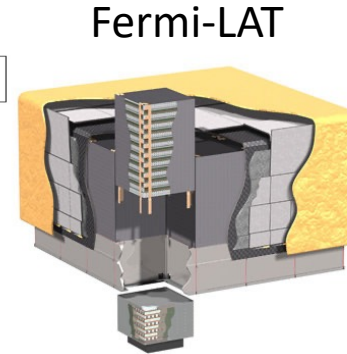
Comptel (1991-2000)  
63 sources 1-30MeV

EGRET (1991-2000)  
271 sources >100MeV

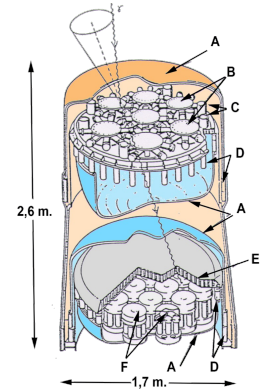
Fermi (2008-)  
6000+ sources >100MeV



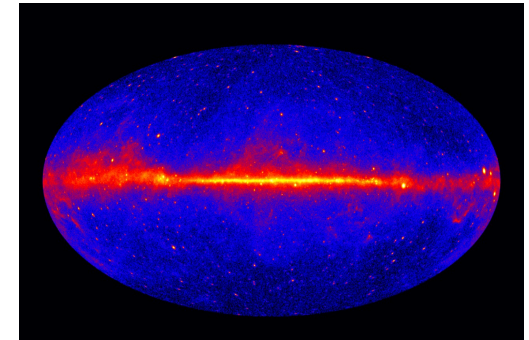
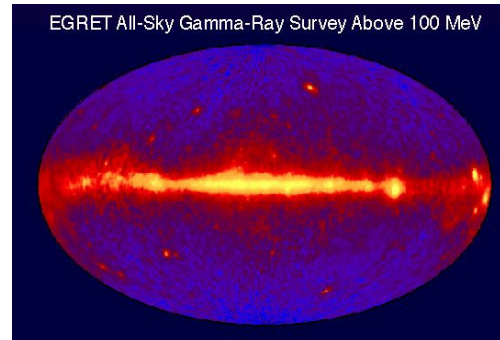
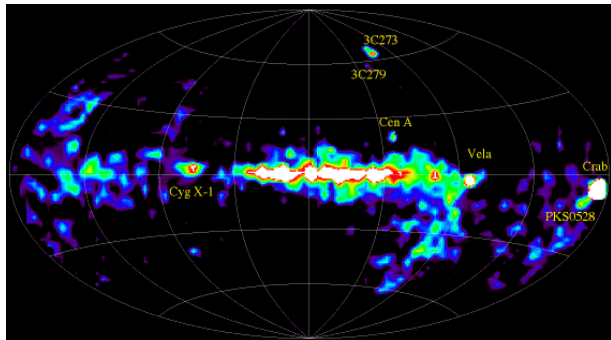
EGRET



Fermi-LAT



Comptel

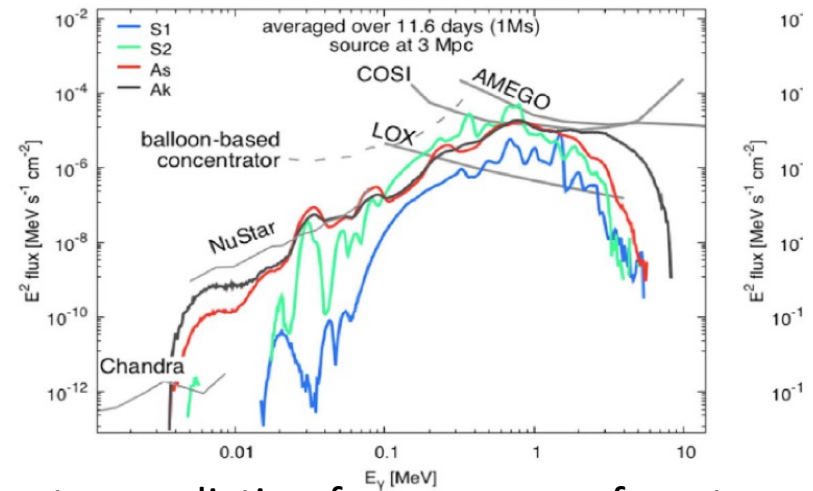
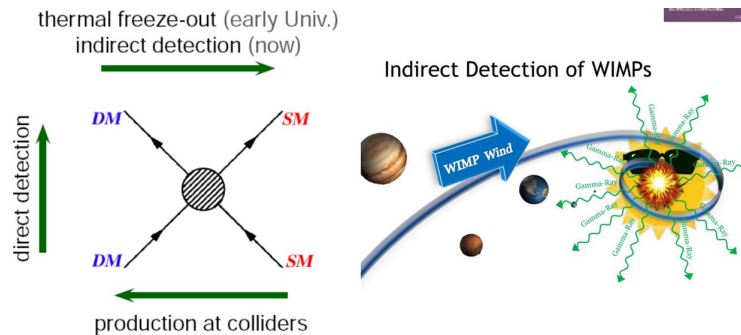


There is great discovery potential for the MeV gap

# MeV $\gamma$ -ray astronomy

□ Studying the origin, composition, and evolution of the universe, and other related phenomena.

- MeV spectral line astronomy
- Ultra-high-energy neutrinos and cosmic rays
- MeV bremsstrahlung
- Sub-GeV dark matter and primordial black holes
- MeV polarization



Gamma spectra prediction from merger of neutron stars

A brand-new astronomical observation window for MeV  $\gamma$  rays

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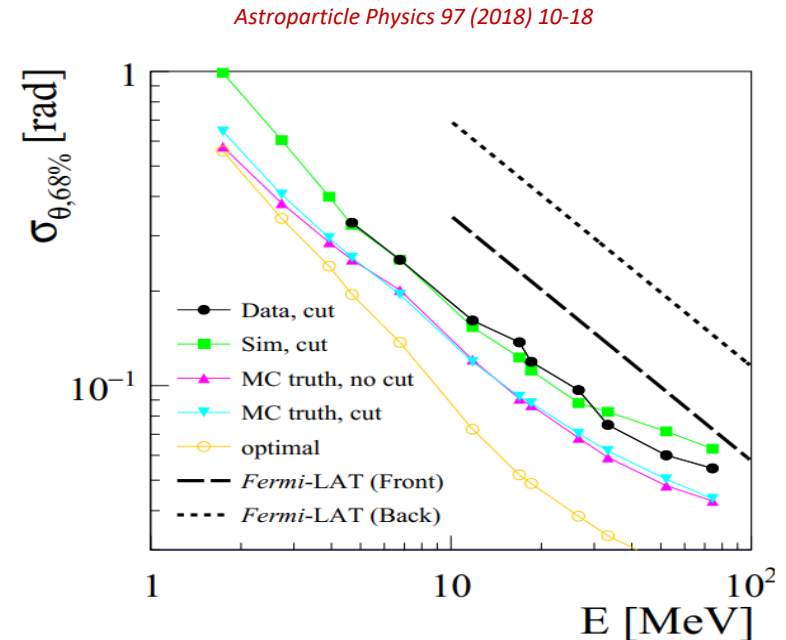
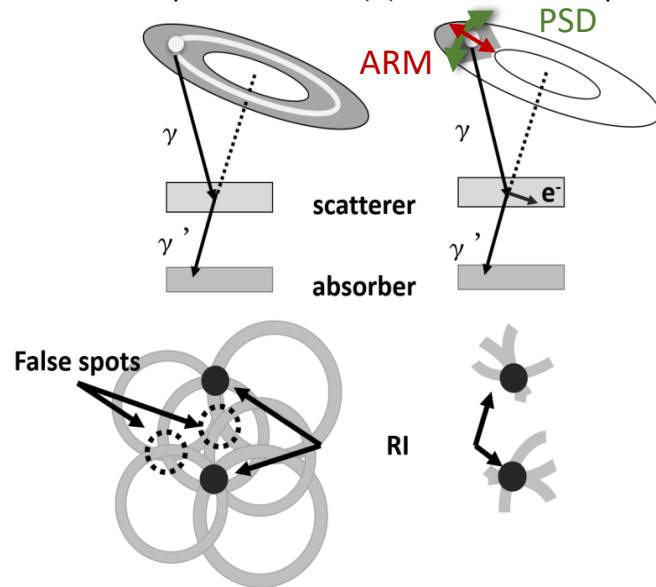
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# Key technological challenges

- ❑ The energy is too high to be collimated
- ❑ It is difficult to measure **3D trajectories of electrons**, that produced in Compton scattering and pair conversion according to Coulomb multi-scattering.

(a) Classical Compton camera (b) Advanced Compton camera



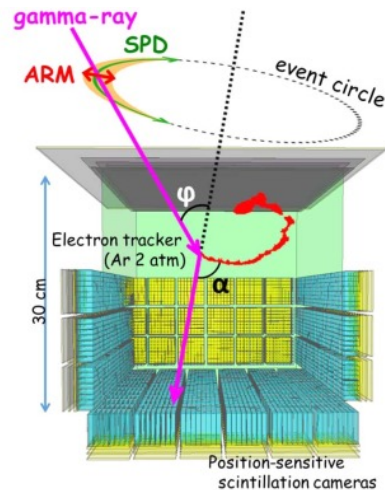
It is practical to improve the e-tracking measurement by reducing the material density with gas detectors

# Some experimental proposals

SMILES (0.3-3MeV)

TPC Compton camera

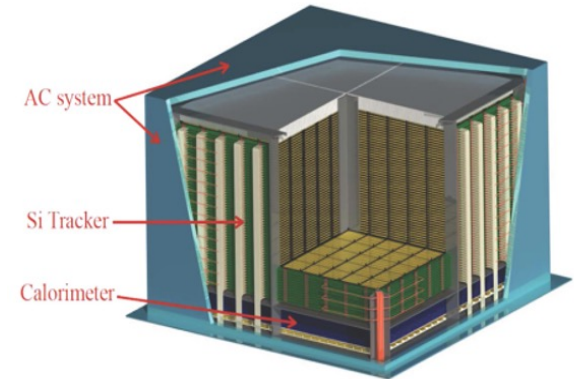
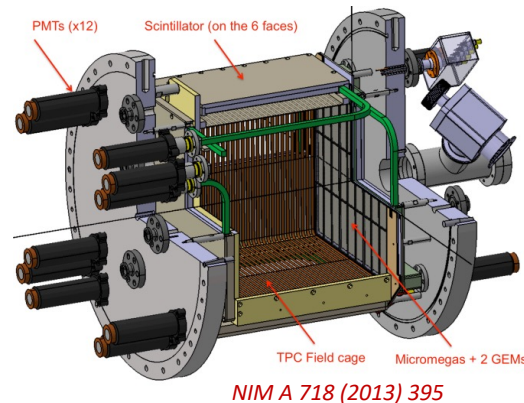
*The Astrophysical Journal*, 930:6 (13pp), 2022 May 1



e-ASTROGAM (0.3MeV-3GeV)

Silicon gamma telescope

*Journal of High Energy Astrophysics* 19 (2018) 1–106



HARPO (MeV-GeV)

TPC Gamma polarization measurement

Advantages of 3D e-tracking with TPC

- Providing **Scattering plane limits** to reduce background
- Achieving optimal angular resolution by **lowering electron scattering**
- Electron emission angles carrying **polarization information**

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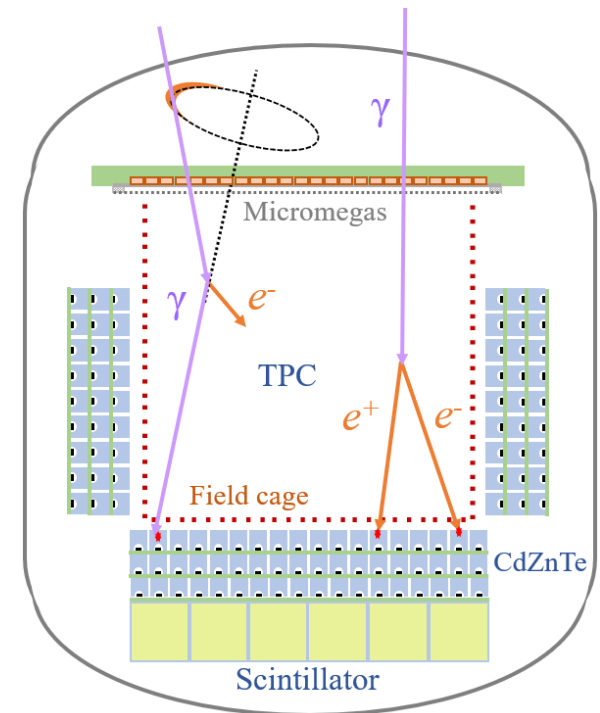
# Conceptual design

## ▣ TPC based technique

- 30 cm cubic volume (prototype)
- four 50 cm cubic or a single 100 cm  $\times$  100 cm  $\times$  50 (or larger) cm volume (satellite)
- 3-10 bar high pressure

## ▣ Expected performance

- High dynamic range:  
0.3 MeV - 100 MeV
- Angle resolution (PSF):  
**2°** @ MeV, **0.5°** @ 100 MeV

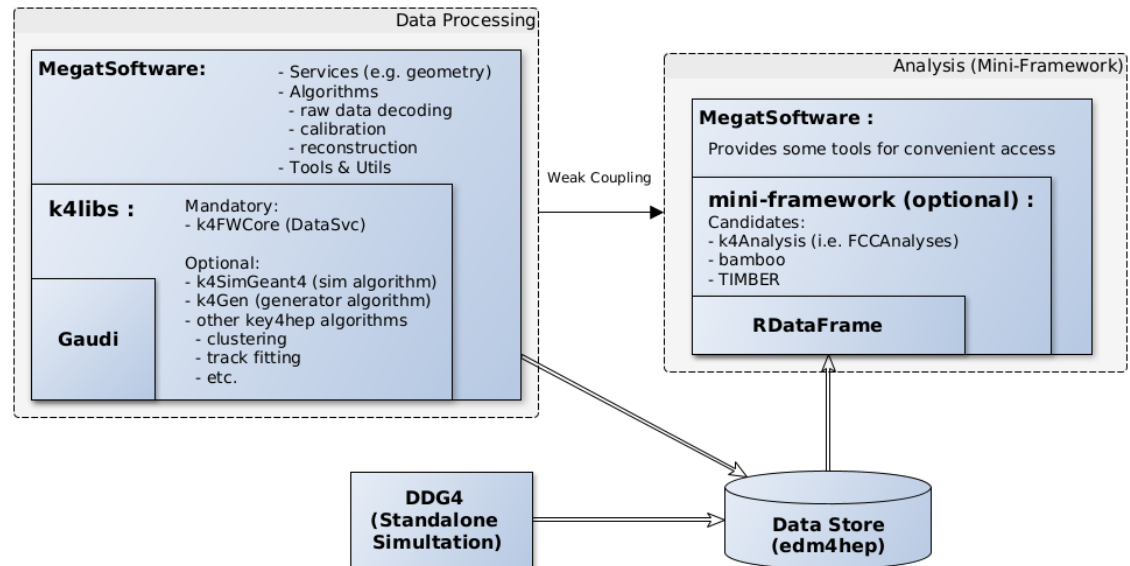


# Software framework

Goal: single software for simulation, reconstruction & analysis

## Software stacks:

- Simulation:
  - k4SimGeant4
- Event data model:
  - EDM4hep
- Event-processing:
  - Gaudi
  - k4FWCore



## Data processing (on server):

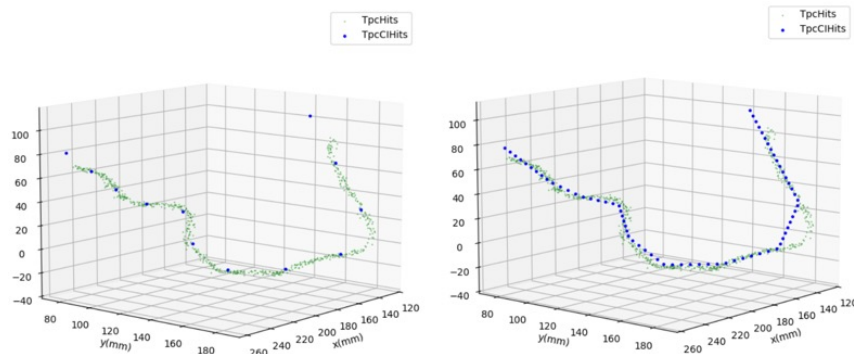
- official data production:
  - simulation & reconstruction
  - standardized & trackable
- flexible kernel:
  - Gaudi

## Exploratory analysis (on desktop):

- personal data analysis:
  - quick turn-around workflow
- lightweight kernel:
  - RDataFrame (ROOT)

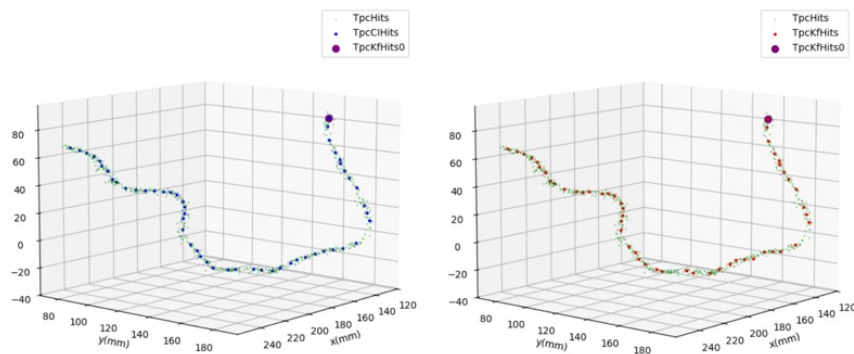
# Simulation performance

- Track reconstruction of recoil electron by Kalman Filter Algorithm



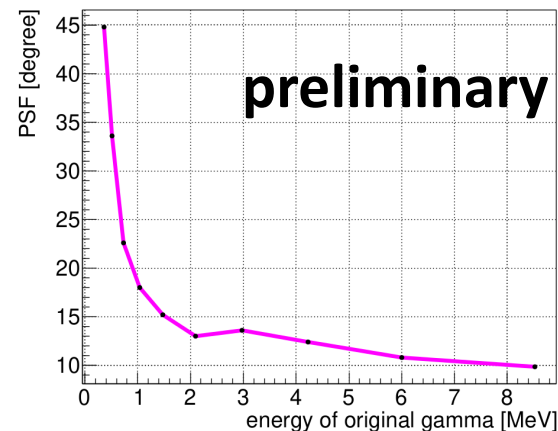
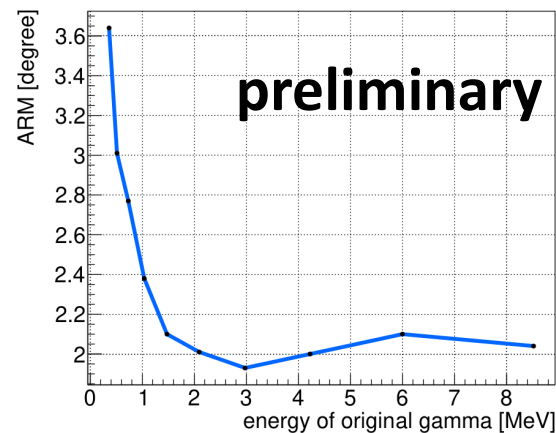
1.clustering

2.interpolation



3.get charge center

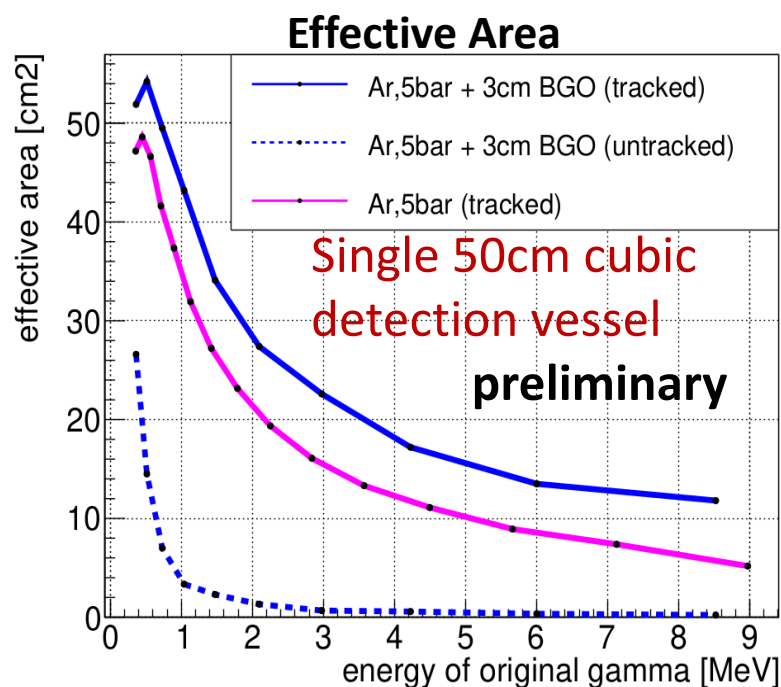
4.Kalman filter



# Simulation performance

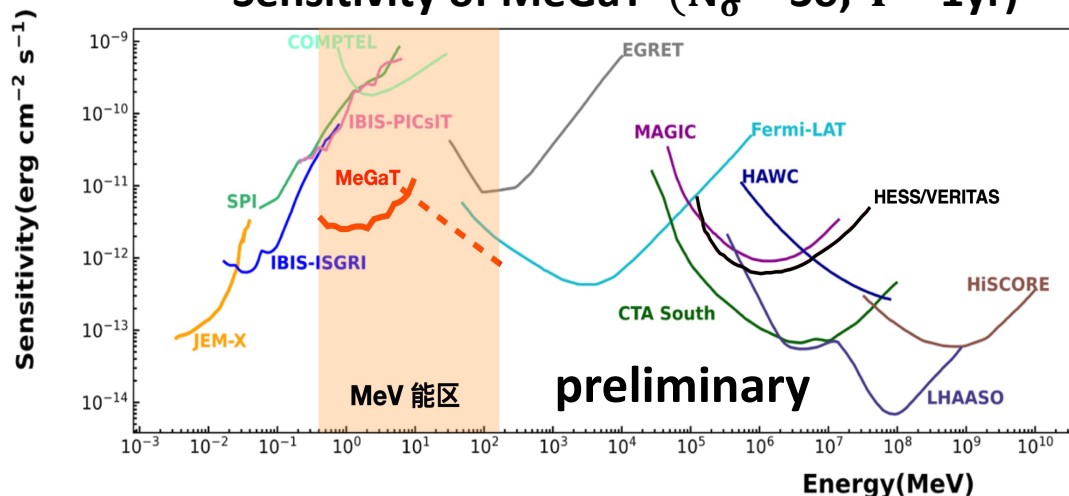
Four identical 50cm cubic detection vessels

- Very preliminary simulation result without pair conversion
- Rough estimation by taking pair into account



$$S = \frac{N_{\sigma} \sigma_{\theta} E^2}{\epsilon_{68} \Delta E} \sqrt{\frac{\pi \int B(E) dE}{A_{eff} T}}$$

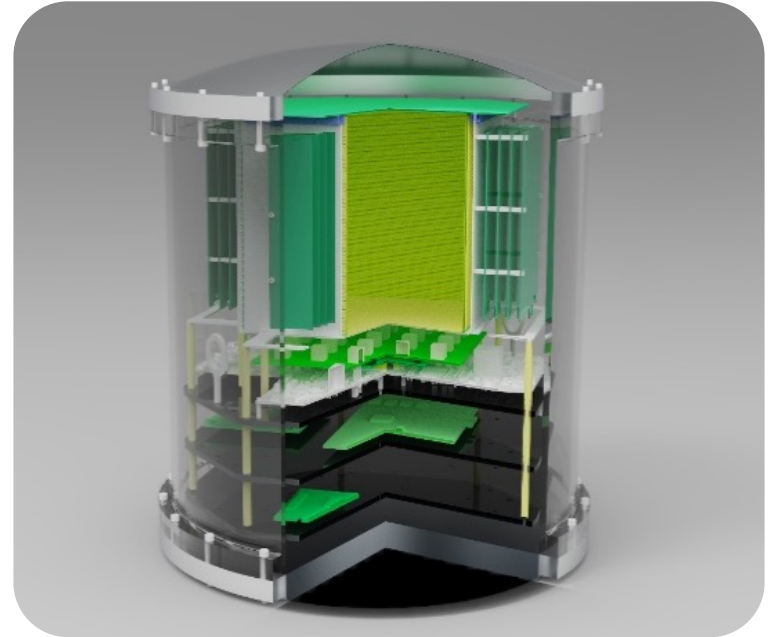
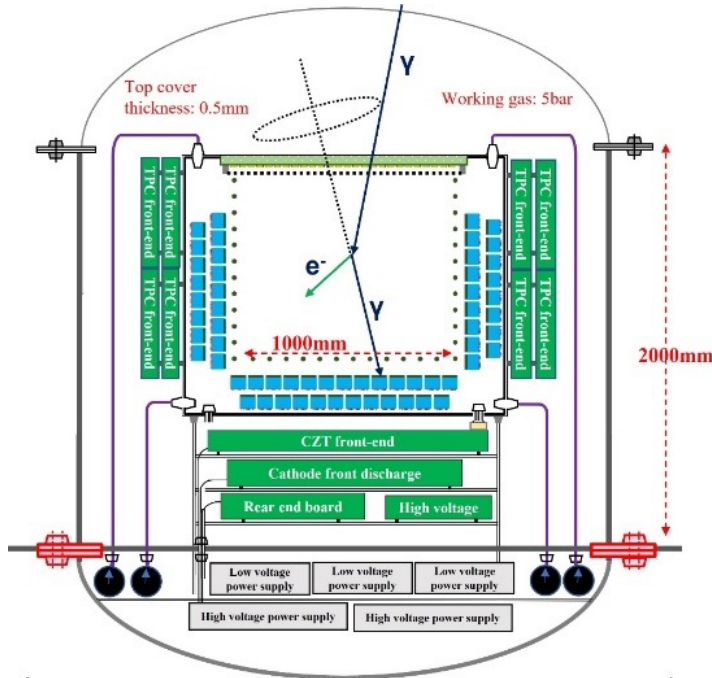
**Sensitivity of MeGaT ( $N_{\sigma} = 3\sigma$ ,  $T = 1\text{yr}$ )**



Perfect performance on spatial and energy resolution are required for the TPC and calorimeter

# Prototype of R&D

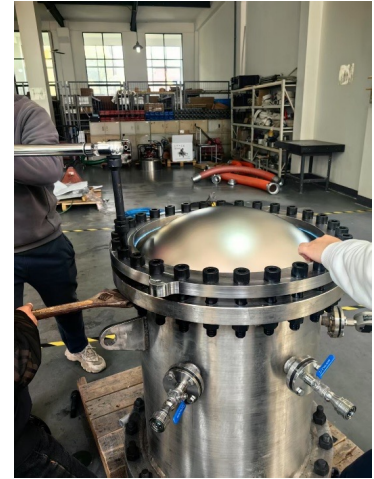
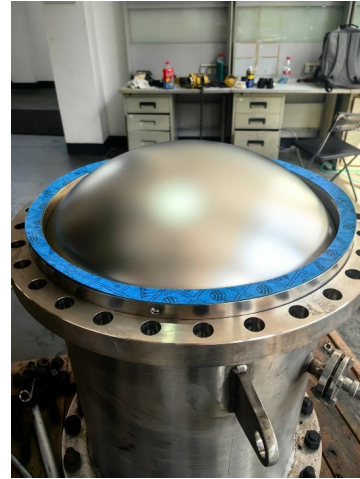
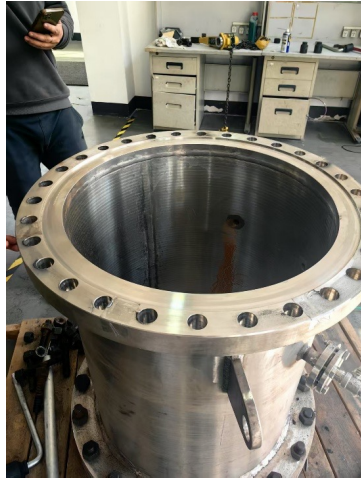
- 30 cm cubic volume



## Technical challenges

- High voltage: Micromegas  $\sim 3000V$ , Field cage  $\sim 15000V$
- High-pressure sealing: 0.5 Mpa
- Mechanical support and heat dissipation issues

# 罐体耐压测试



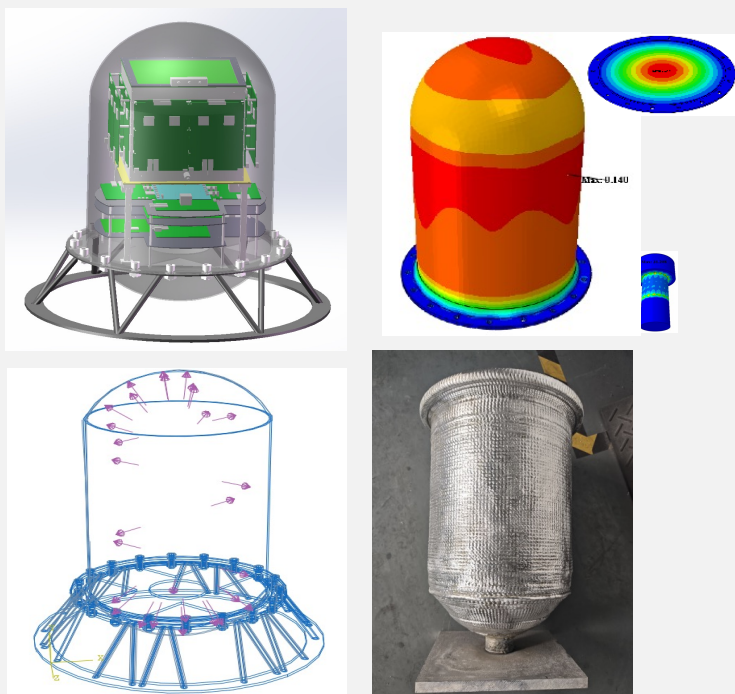
|    |          |       |       |       |       |         |
|----|----------|-------|-------|-------|-------|---------|
| 日期 | 3月21日    | 24日   | 25日   | 26日   | 28日   | 28日     |
| 气压 | 0.489MPa | 0.489 | 0.491 | 0.494 | 0.486 | 0.689   |
|    | 1周保压测试   |       |       |       |       | 1小时过压测试 |



窗口厚度0.4mm不锈钢，气压可达到7bar，但是总重接近700公斤！

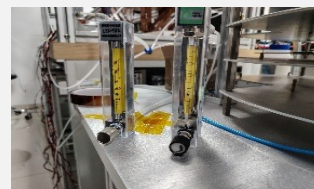
# 结构优化设计与试验

## 罐体结构轻量化



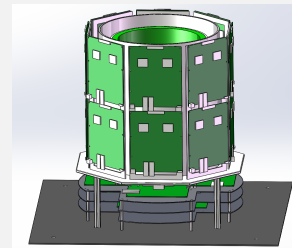
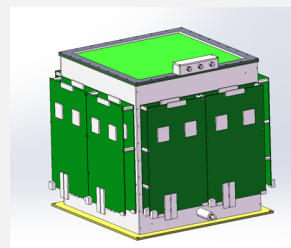
尝试3D打印新技术，窗口厚度  
~3mm铝合金，承压更强；  
罐体重量降低10倍以上（不锈钢为  
670公斤）

## TPC结构优化

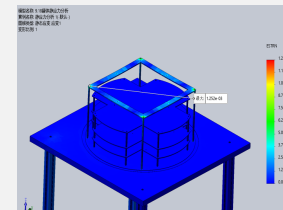
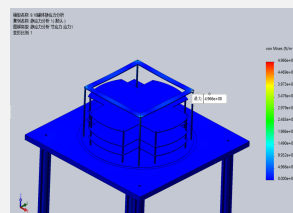


TPC通气测试进  
行2周，没有明显  
漏气

| 时间 (hour)    | 0  | 12 | 24 | 36 | 48 |
|--------------|----|----|----|----|----|
| 进气量 (ml/min) | 35 | 35 | 35 | 35 | 35 |
| 出气量 (ml/min) | 35 | 32 | 30 | 30 | 30 |

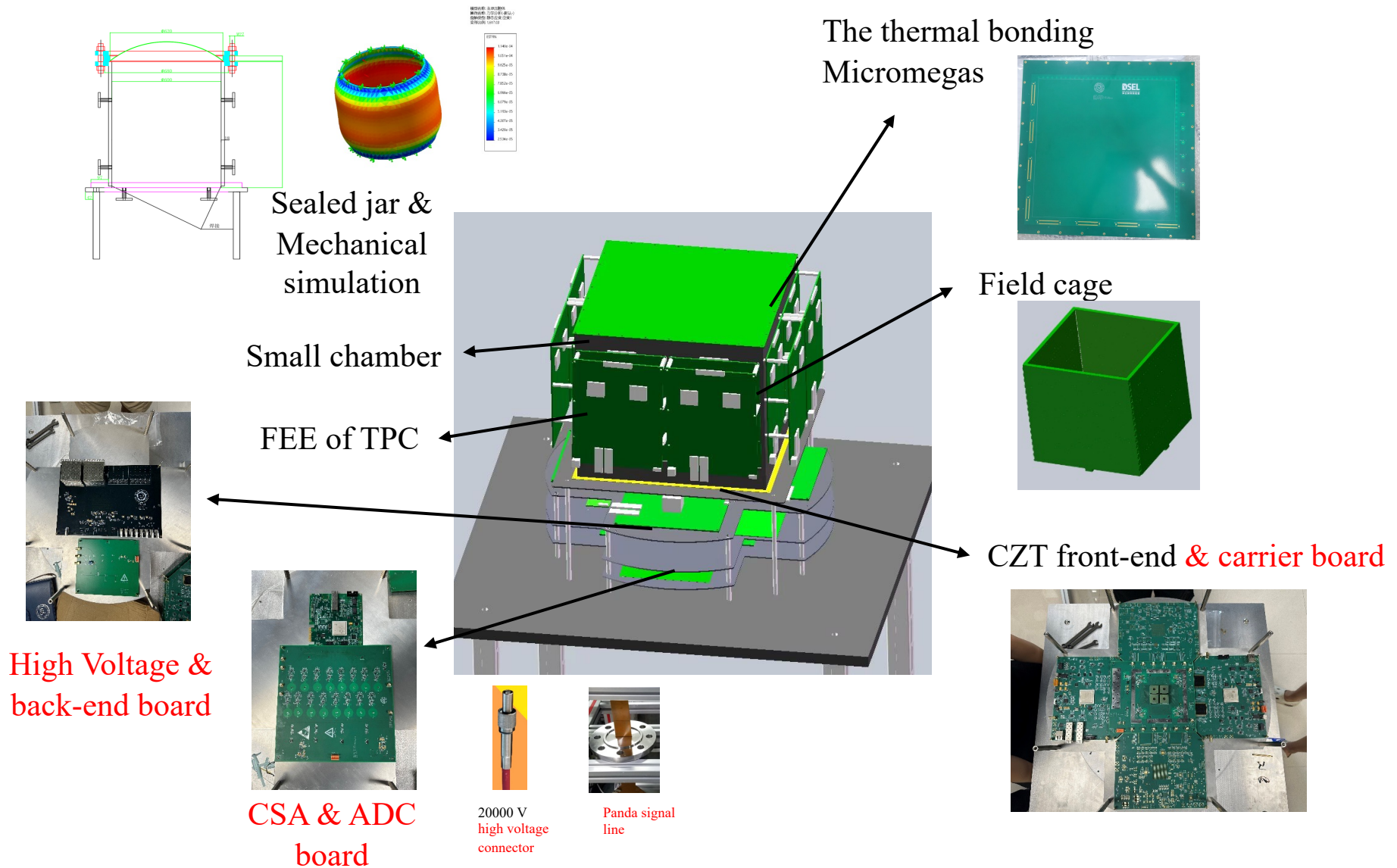


同样基于3D打印进行优化



受力及应变仿真，对整体结构进行仿  
真，仿真载荷取实际载荷的约1.5倍

# Prototype of R&D



# Readout Electronics

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## ❑ Challenges:

- Large mount of readout channels
- High dynamic range, low noise
- Multiple detector system

## ❑ Solutions:

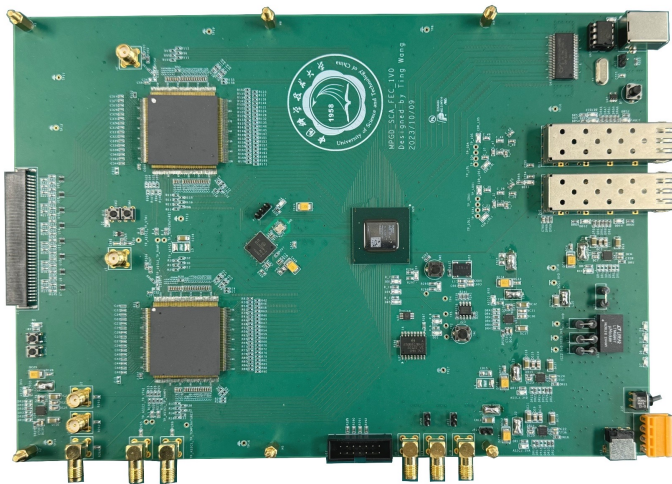
- Encoding Method to minimize the readout channels
- Develop low noise FEE with dedicated ASIC
- Modular design to ensure the extensibility of the system

# FEE for the TPC

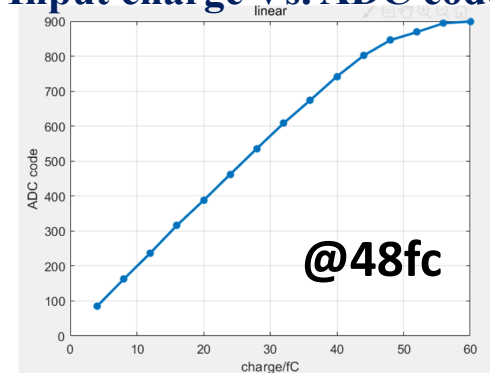
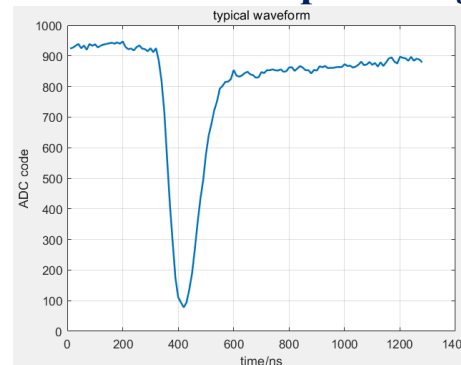
## All-digital output ASIC (design by Professor L. Zhao)

- High-Speed Switched Capacitor Array (SCA) & Wilkinson ADC
- The development of the front-end readout board has been completed, and performance testing is underway

|                              |                                             |
|------------------------------|---------------------------------------------|
| <b>Dynamic range</b>         | <b>48 fC-1pC</b>                            |
| <b>INF</b>                   | <b>&lt; 1%</b>                              |
| <b>Shaping Time</b>          | <b>70ns-1us</b>                             |
| <b>Maximum sample rate</b>   | <b>160 MSPS</b>                             |
| <b>Sample units</b>          | <b>128 cells</b>                            |
| <b>Noise (RMS)</b>           | <b>&lt; 0.5 fC @ 48fC</b>                   |
| <b>Timing precision(RMS)</b> | <b>&lt; 1 ns @ 48fC</b>                     |
| <b>Dead time</b>             | <b>&lt; 75 <math>\mu</math>s @ 120 MSPS</b> |



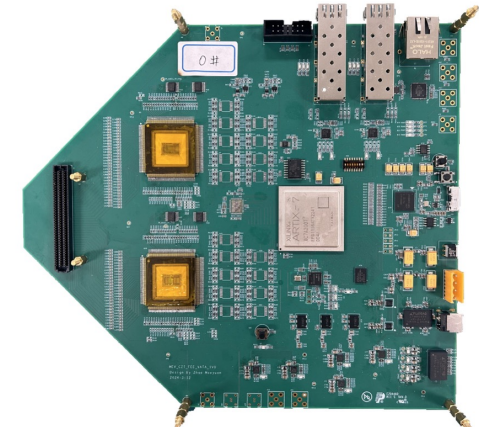
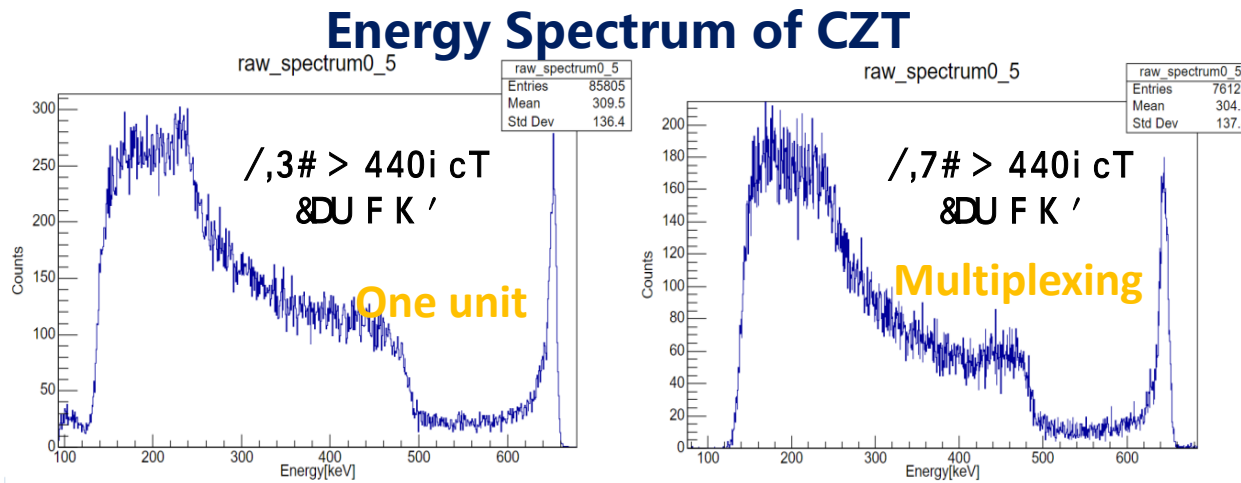
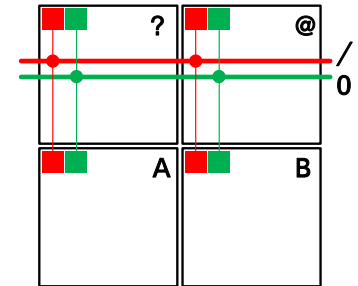
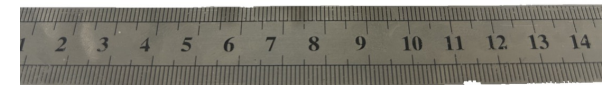
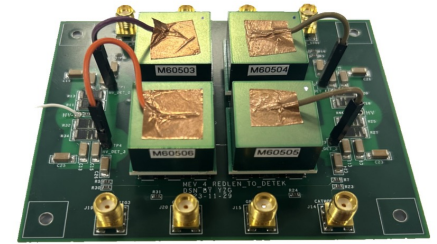
Result of 48fC input charge Input charge Vs. ADC code



# FEE for the CZT

## Multiplexing method

- Multiple pads of different detectors can be connected to one readout channel.
- The cathode signal of CdZnTe shows which detector has been hit.



# Summary

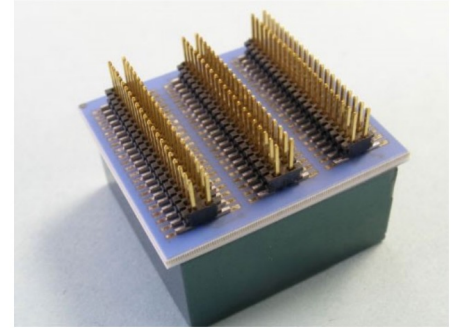
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- ❑ MeGaT is aiming to open up the MeV  $\gamma$ -ray observation window with very high sensitivity.
- ❑ Technologies are innovative and challenging, but are proven to be reliable.
- ❑ First 30 cm cubic prototype will be built and characterized with photon beam soon.

# Channel encoding method

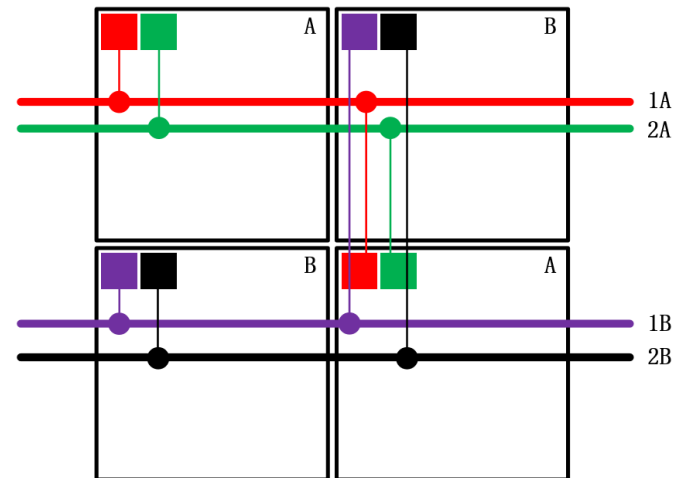
## Pixelate CZT

- $20 \times 20 \times 15 \text{ mm}^3$  size for single piece
- 121-pixel array with 1.72 mm-pitch
- **128k channels** in total for a 30 cm cubic prototype



## Encoding method

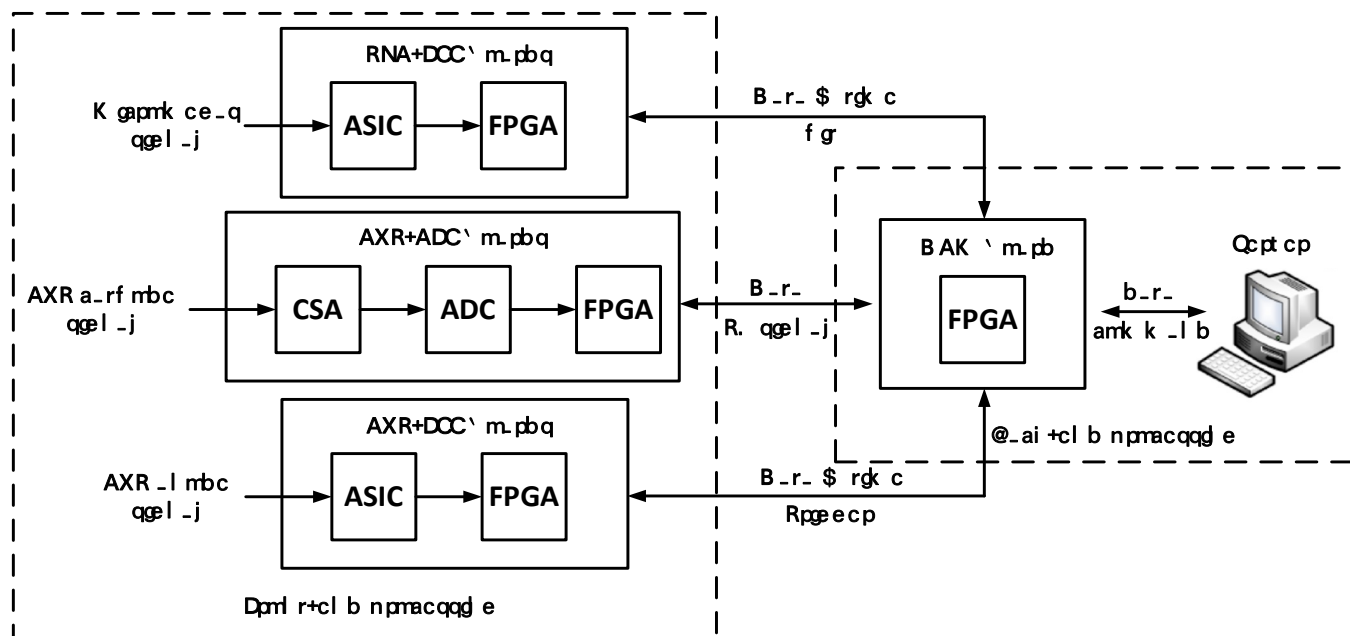
- Multiplexing readout channels for the pads from different CZTs.
- The cathode signal gives the judgement.
- The channel number is expected to be reduced with a factor of more than 10.



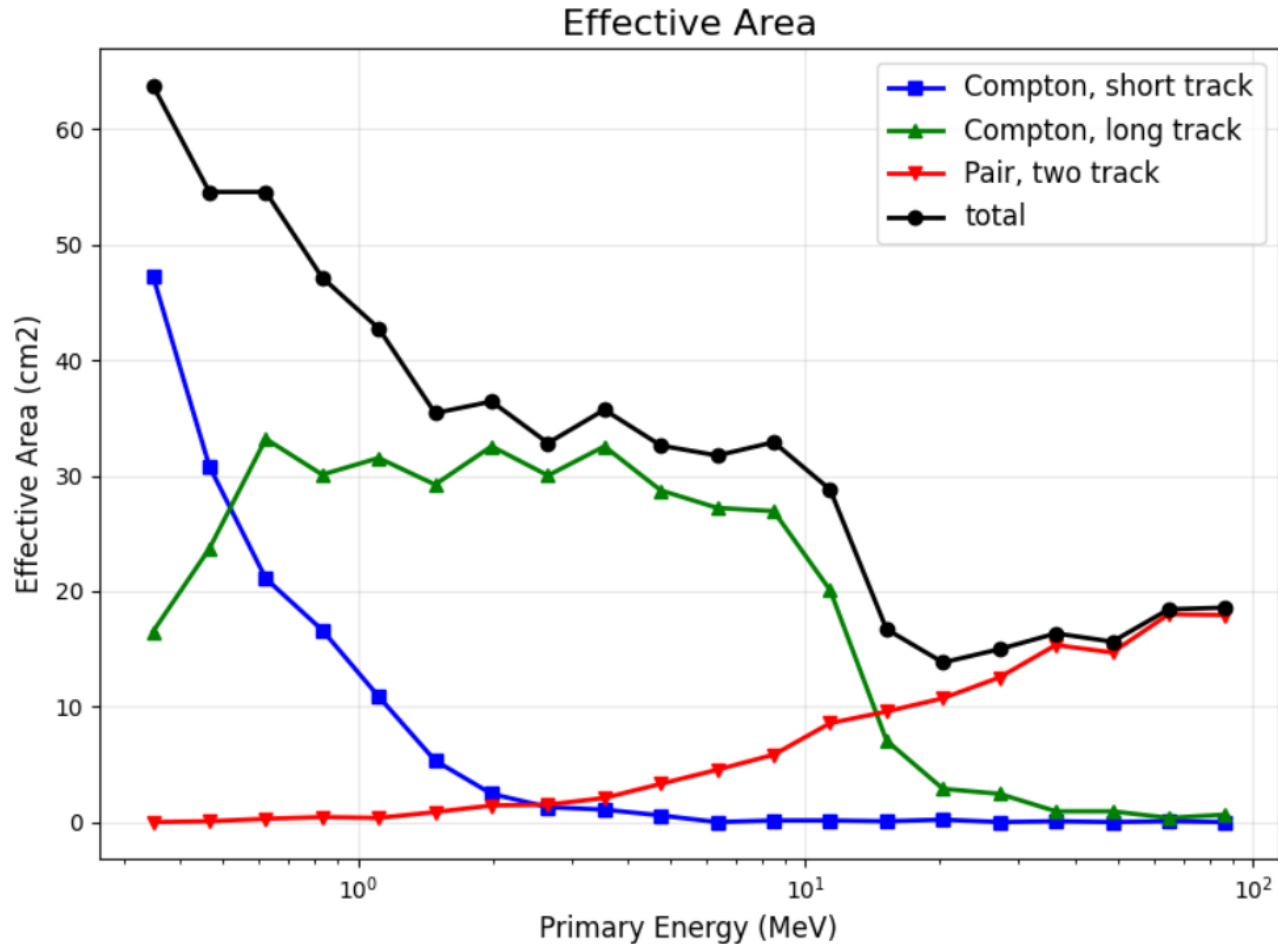
# Schematic design for system

## Multiple detector system

- High dynamic range, low noise FEEs
- T0 from cathode signal of CZT
- Encoding readout to minimize the channel number
- Modular design for extensibility

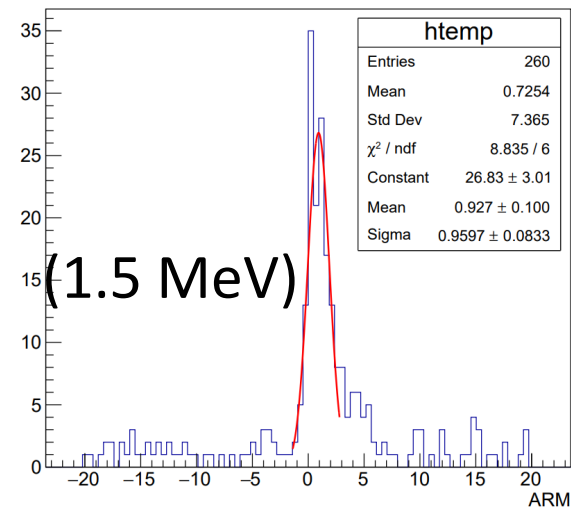
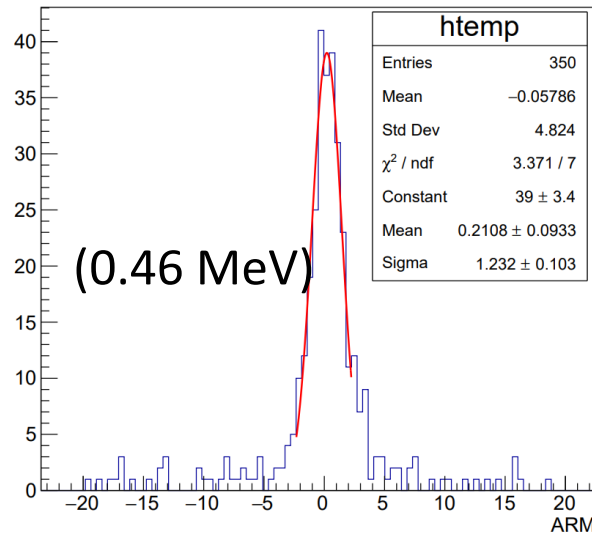


# 有效面积估计（考虑事例重建效率）

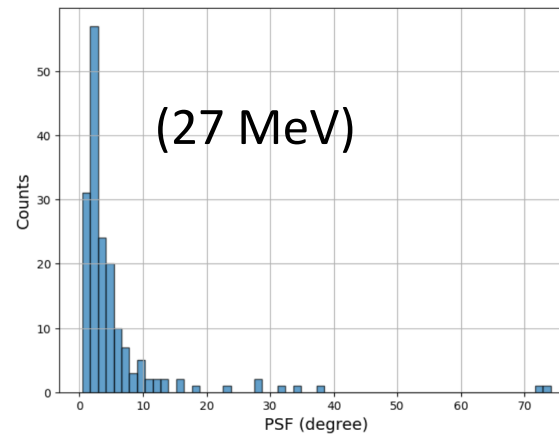


各种类型事例对应的有效面积随原  
初 $\gamma$ 能量的变化

# 入射角度重建

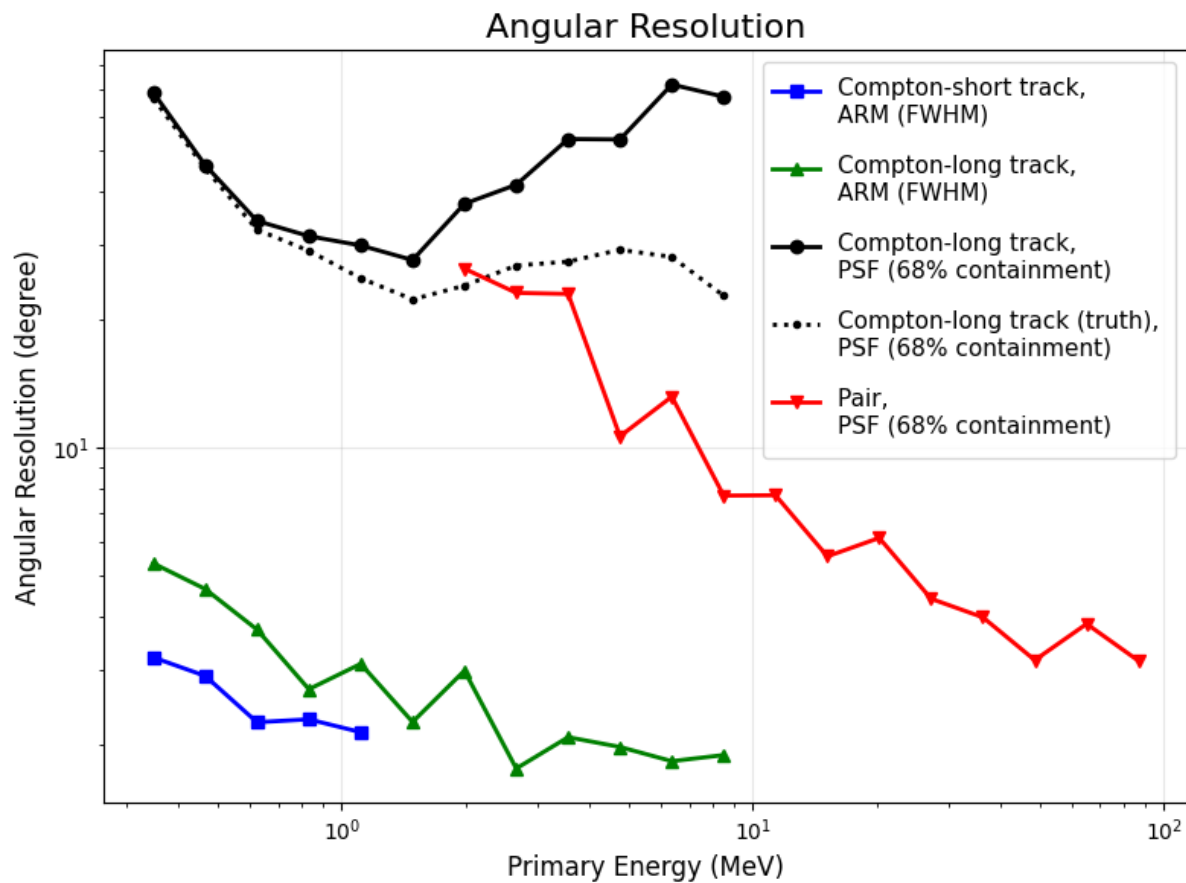


短径迹、长径迹康普顿散射事例ARM拟合



电子对产生事例PSF

# 角分辨计算

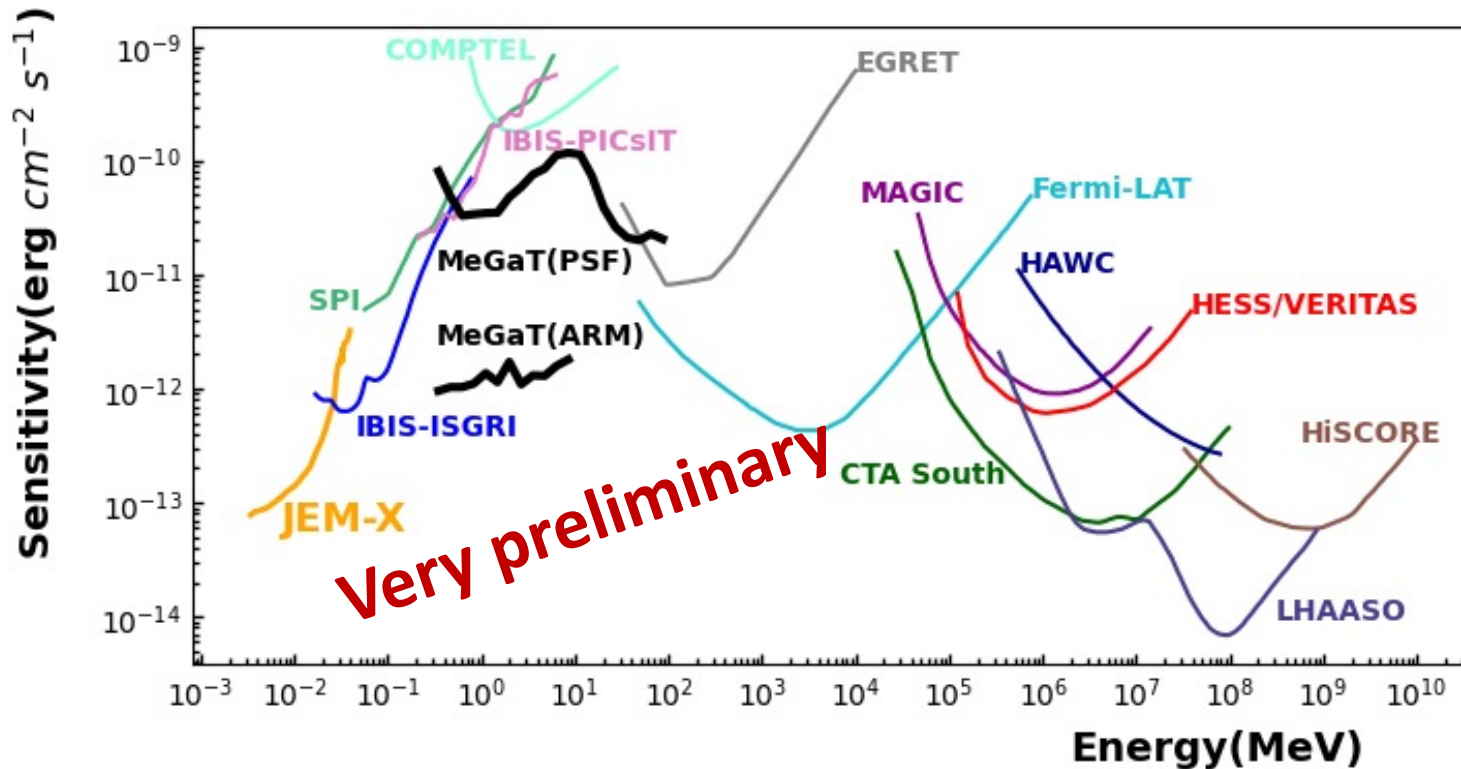


各种类型事例对应的角分辨随原初 $\gamma$ 能量的变化

# MeGaT灵敏度估计

$50 \times 50 \times 50 \text{ cm}^3 \text{ TPC}$

$$S = \frac{N_\sigma \sigma_\theta E^2}{\epsilon_{68} \Delta E} \sqrt{\frac{\pi \int B(E) dE}{A_{eff} T}} \quad (N_\sigma = 3\sigma, T = 1\text{yr})$$



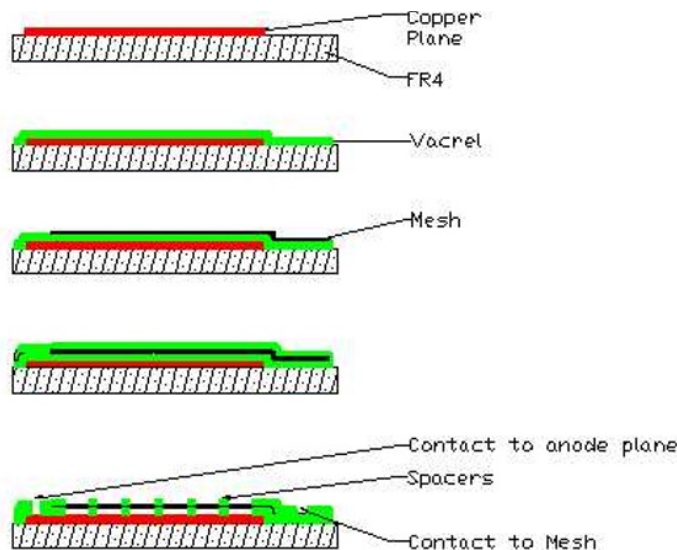
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# Backup slides

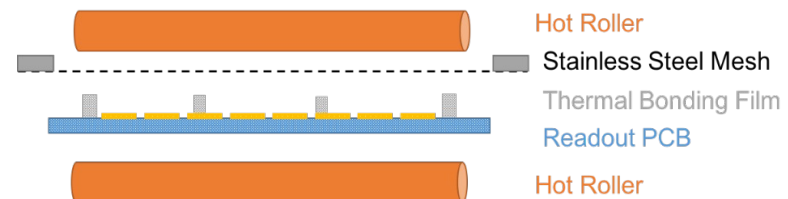
# The thermal bonding method

Over the past decade, We developed a novel thermal bonding method for the efficient fabrication of Micromegas detectors.

## Micromegas in a Bulk

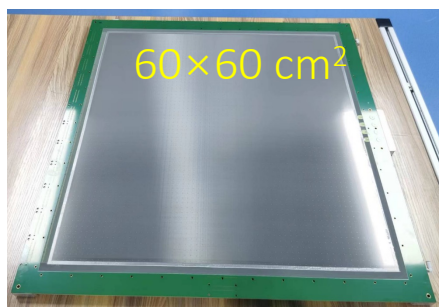
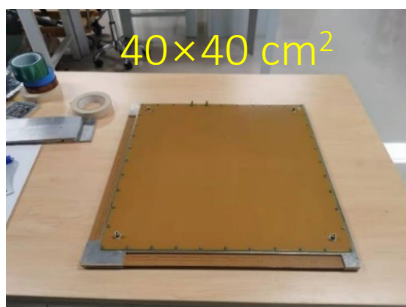


## Thermal bonding processing

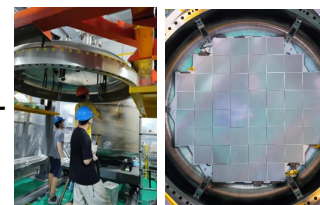


- No etching, no pollution
- Easy to handle at lab
- Easy to make new structures
- $\Phi 0.5\text{mm}$ -  $\Phi 1\text{mm}$  spacers,  $\sim 1\text{cm}$  pitch
  - ➔ easy to clean, especially for large area
  - ➔ less than 1% spacer area

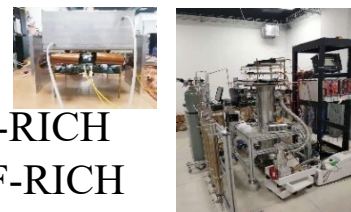
# Fabrication and applications



Neutron detectors for the Chinese Spallation Neutron Source



PandaX-III TPC MM



CEPC-RICH & STCF-RICH



Muography

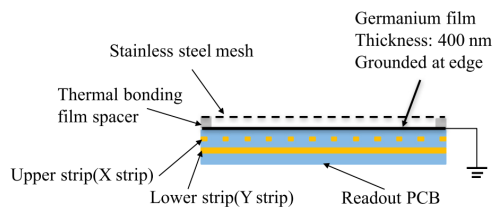
# Performance of the Micromegas detector

## 5.9 keV X-ray test

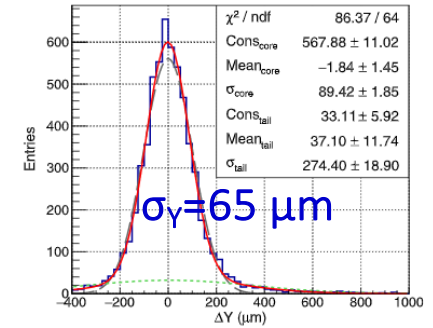
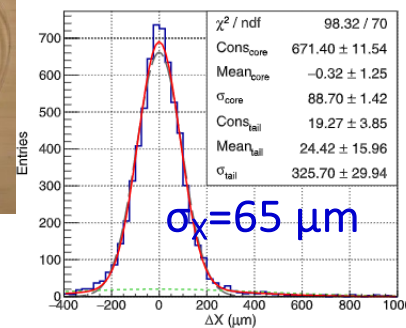
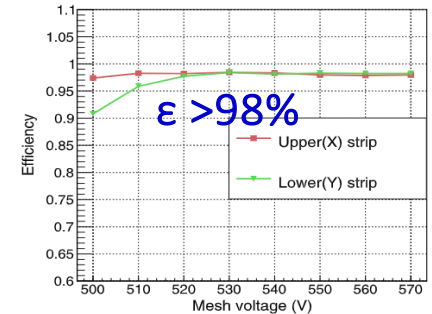
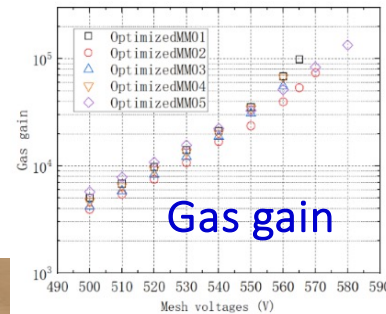
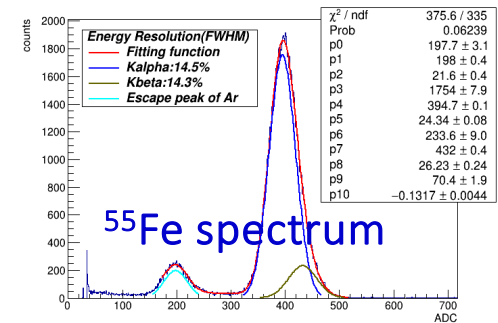
- Gas gain:  $\sim 10^5$  (Ar+7%CO<sub>2</sub>)
- Energy resolution:  $< 15\%$  (FWHM)

## Electron beams (5GeV) at DESY

- X-Y 2D readout
- Efficiency:  $> 98\%$
- Resolution:  $65\mu\text{m}$

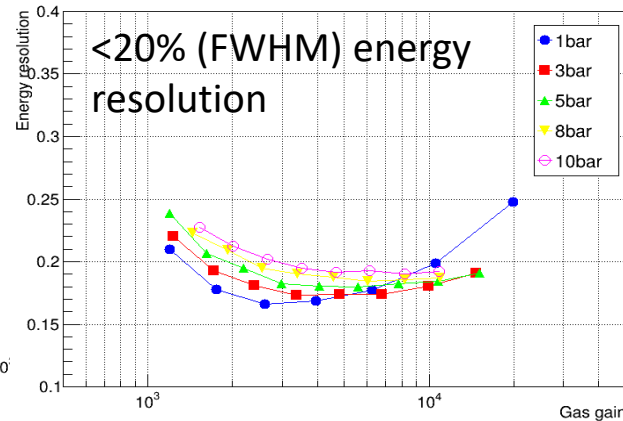
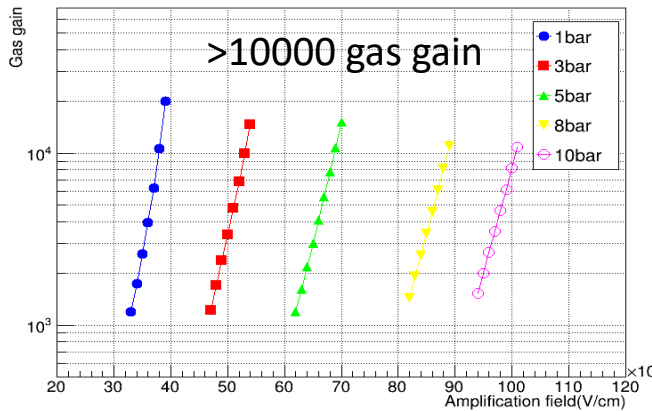
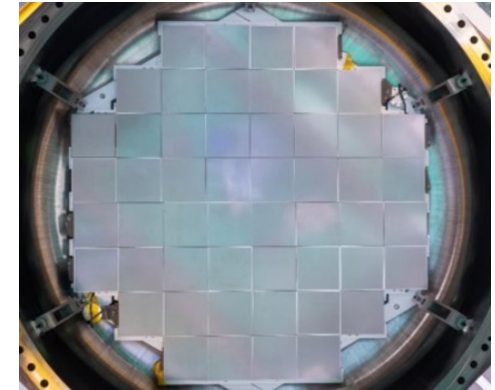
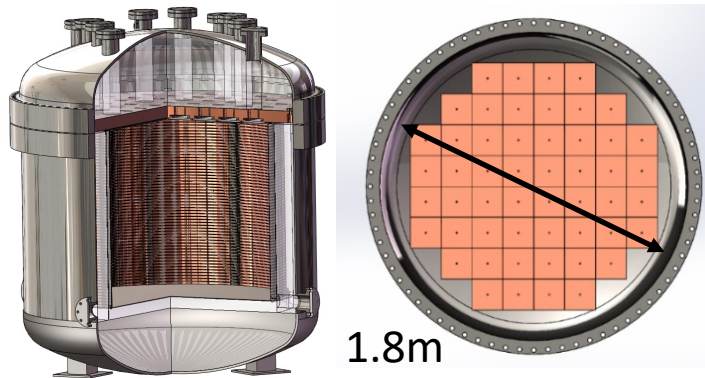


NIM-A 989 (2021) 164958; NIM-A 1031 (2022) 166595.



# Performance of the Micromegas detector

Performance in high gas pressure was studied in the PandaX-III experiment

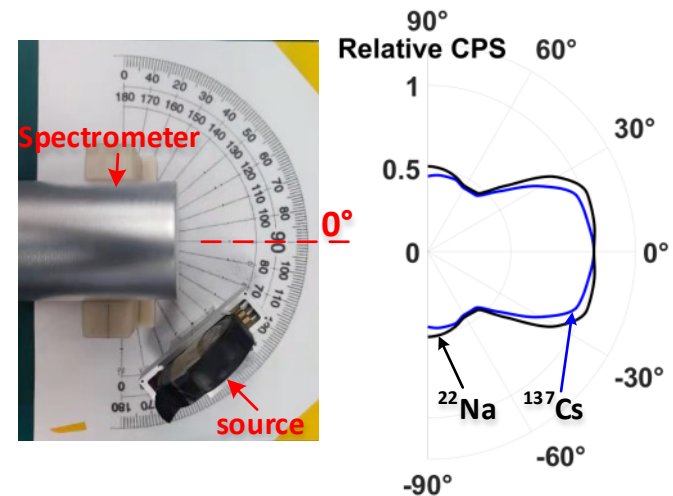
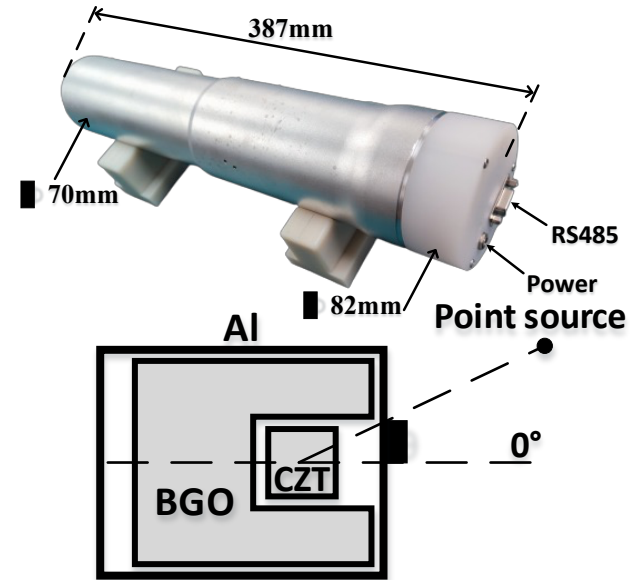
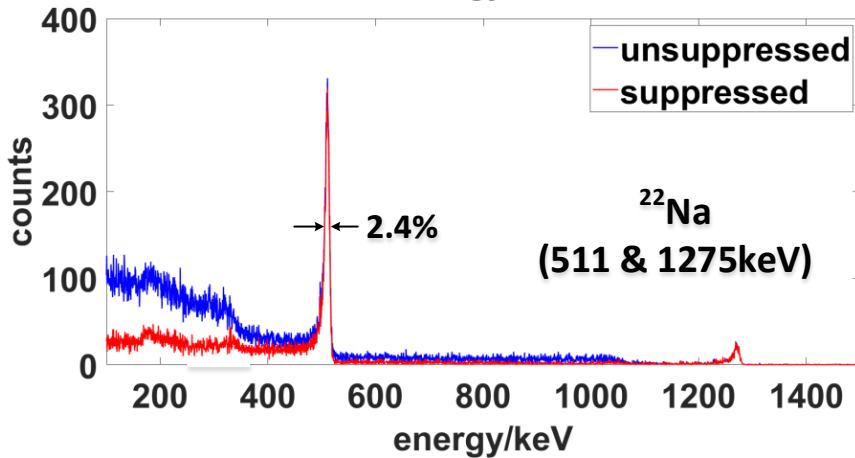
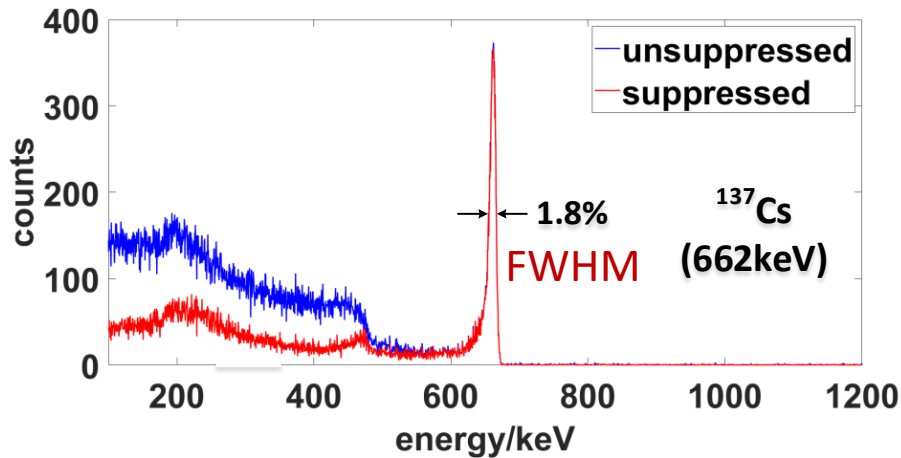


Test at 10bar Ar(2.5% Iso) with a 5.9 keV X-ray source

High gain and good energy resolution were verified in high gas pressure

# Performance of the CZT

## Cadmium zinc telluride (CZT)



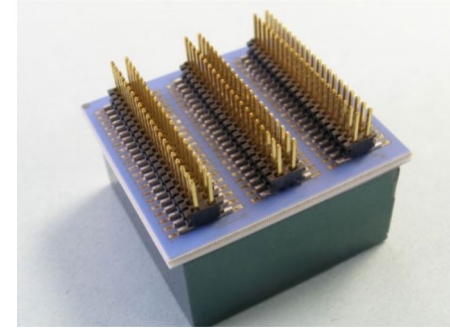
# Channel encoding method

## Pixelate CZT

§  $20 \times 20 \times 15 \text{ mm}^3$  size for single piece

§ 121-pixel array with 1.72 mm-pitch

§ **128k channels** in total for a 30 cm cubic prototype

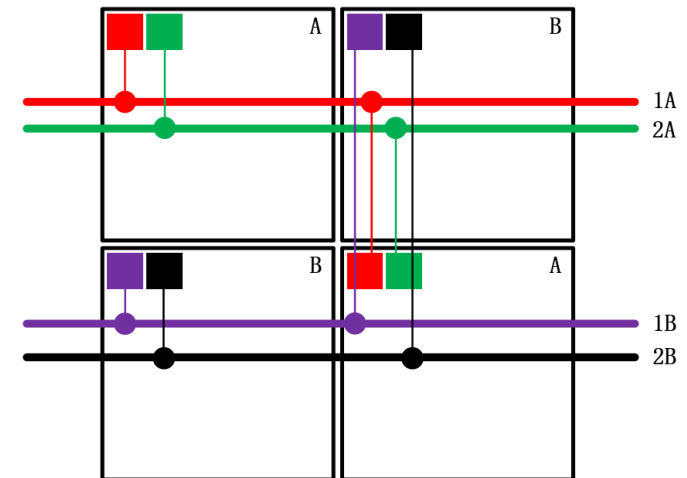


## Encoding method

§ Multiplexing readout channels for the pads from different CZTs.

§ The cathode signal gives the judgement.

§ The channel number is expected to be reduced with a factor of more than 10.



# FEE for the TPC

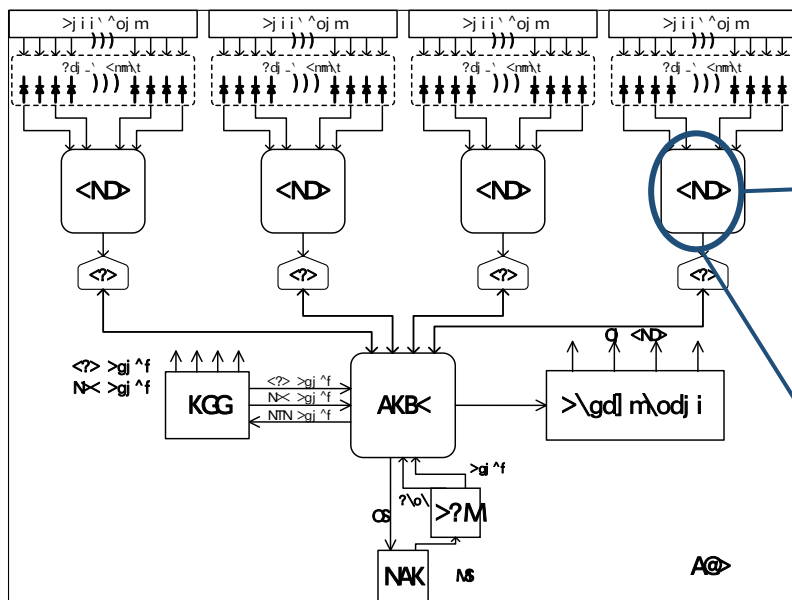
■ There are 1200 signal strips to be readout

for the 2D Micromegas (0.5mm pitch)

■ FEE design for the TPC readout

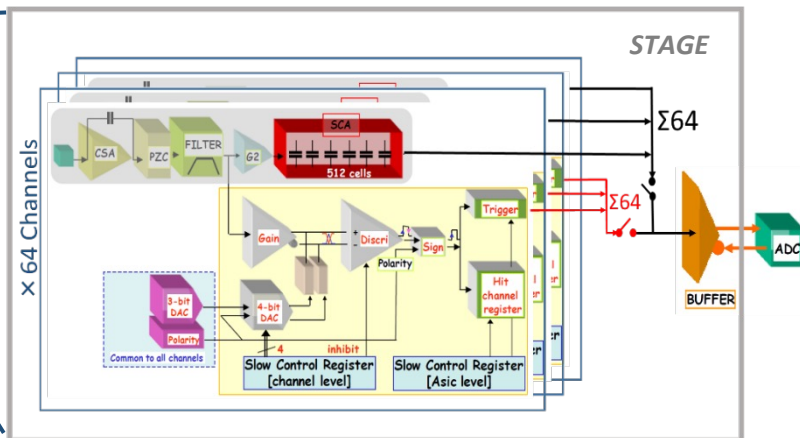
§ Dedicated STAGE chip for TPC (by Saclay France)

§ Each board integrate 4 chips for readout 256 channels



## STAGE chip specifics

- ✓ 64 inputs with dynamic range of 120fC, 1pC, 10pC
- ✓ Shaping time: 50 ns – 1 us (16 values)
- ✓ Noise: < 850 e- (120fC, 200ns, input capacitance < 30pF)
- ✓ INL of charge measure: < 2%
- ✓ Counting rate: < 1kHz



# FEE for the CZT

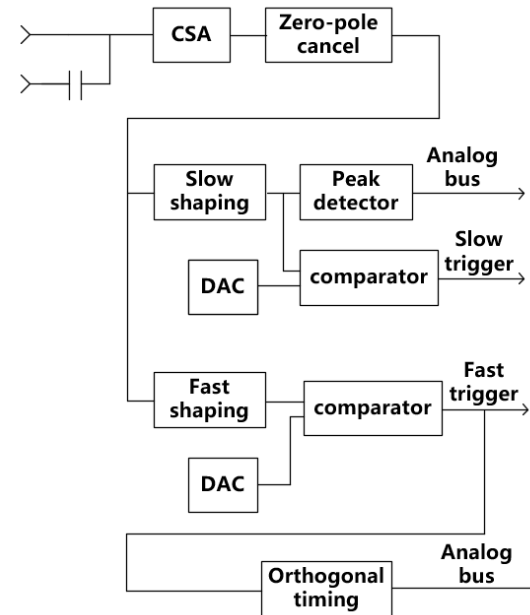
## ❑ Pixelate CZT detectors

§ Wide energy range: 60 keV to 3 MeV

§ Energy Resolution (corrected):  $< 2\%$  @662 keV FWHM

## ❑ Start with the JCF032EB ASIC, optimizing selection for the chip is still in progress

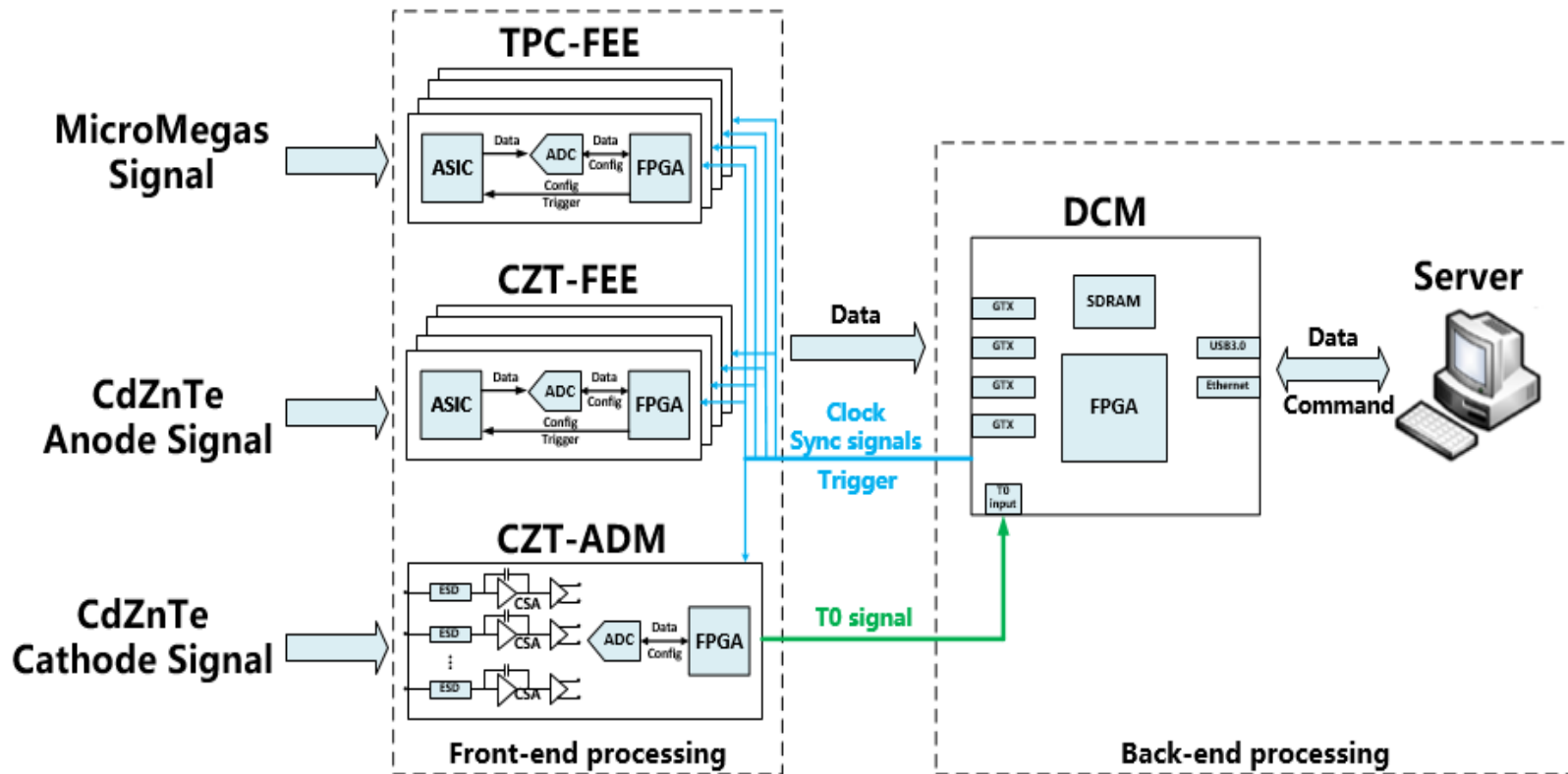
- ✓ 32 inputs
- ✓ Feedback capacitance: 15fF, 60fF, 0.5pF
- ✓ Shaping time: 0.3  $\mu$ s – 40  $\mu$ s
- ✓ Noise RMS: 80e<sup>-</sup> + 12e<sup>-</sup>/pF
- ✓ INL of charge measure:  $< 10\%$
- ✓ Counting rate:  $< 200$  kHz



# Schematic design for system

## □ Multiple detector system

- High dynamic range, low noise FEEs
- T0 from cathode signal of CZT
- Encoding readout to minimize the channel number
- Modular design for extensibility

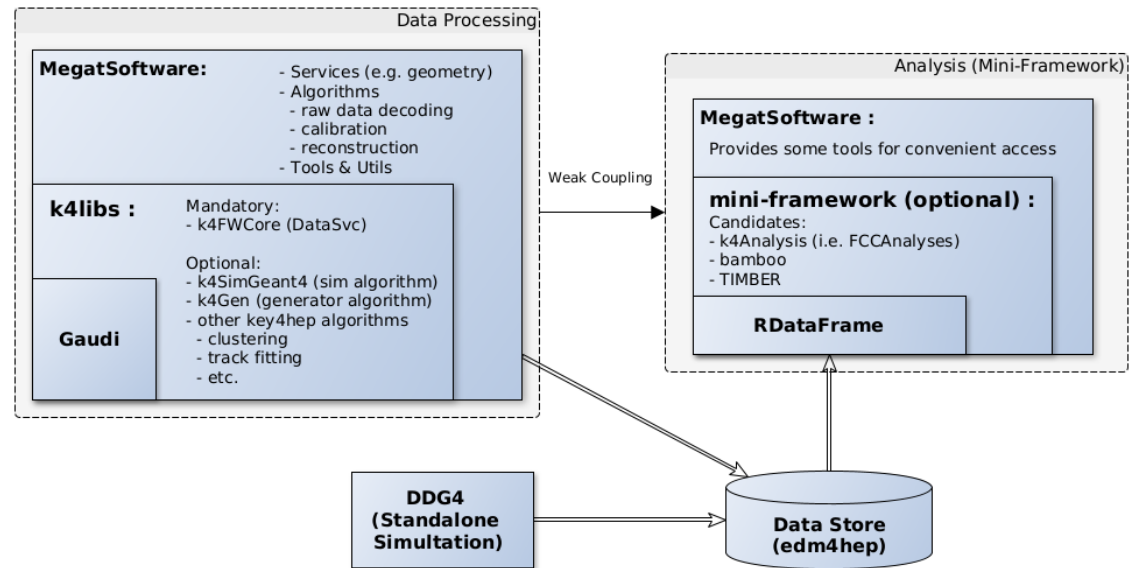


# R&D status: software framework

Goal: single software for simulation, reconstruction & analysis

## Software stacks:

- Simulation:
  - k4SimGeant4
- Event data model:
  - EDM4hep
- Event-processing:
  - Gaudi
  - k4FWCore



## Data processing (on server):

- official data production:
  - simulation & reconstruction
  - standardized & trackable
- flexible kernel:
  - Gaudi

## Exploratory analysis (on desktop):

- personal data analysis:
  - quick turn-around workflow
- lightweight kernel:
  - RDataFrame (ROOT)

# Current status of simulation package

## Geometry features

### 1. Persistence format:

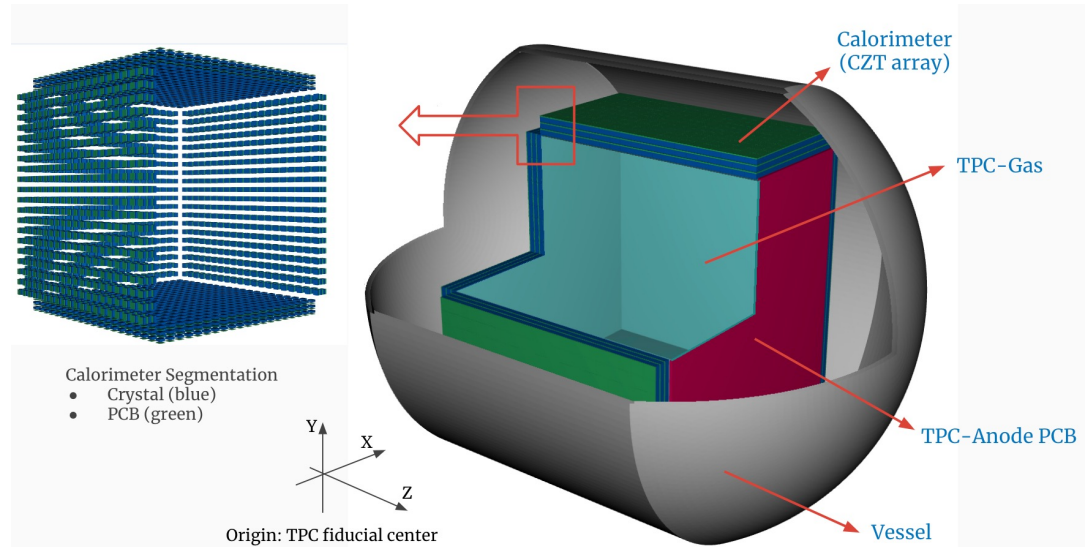
- *XML* (dd4hep-native)
- Covertible: *TGeo*, *GDML*

### 2. Fully-parameterized model:

- Calorimeter
  - CZT-array + PCB-array
- TPC
  - Gas + Anode-PCB + FieldCage

### 3. Tessellated CAD model:

- Vacuum-vessel



## Geant4 Running Engine

### option 1: Gaudi-integrated

- Single-threaded
- No MC truth

### option 2: Standalone process

- *ddg4* (dd4hep-native)
- Multi-threaded support
- MC truth support

## Sensitive Detector

### Calorimeter crystal:

- multi-steps per Hit

### TPC gas:

- one-step per Hit

## Readout segmentation

### Calorimeter:

- Pixel

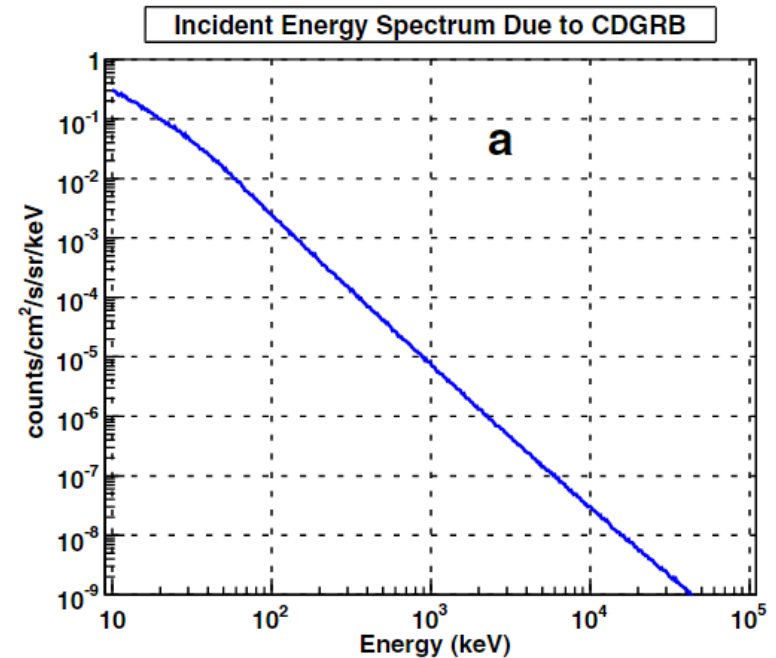
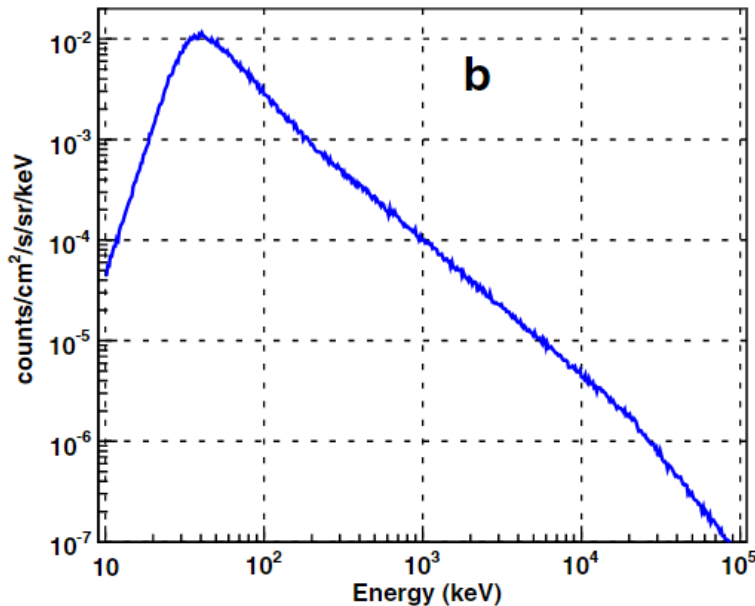
### TPC:

- Strip/Pixel
- Extra stage needed in digitization
- Surface attached to PCB
  - Drift distance determination
  - Coordinate transformation

# Background estimate[1]

## 1. albedo gamma-ray

$$\frac{dN}{dE} = \begin{cases} \frac{1.87 \times 10^{-2}}{\left(\frac{E}{33.7}\right)^{-5.0} + \left(\frac{E}{33.7}\right)^{1.72}} & \text{if } E \leq 200.0 \text{ keV} \\ 1.01 \times 10^{-4} \left(\frac{E}{\text{MeV}}\right)^{-1.34} & \text{if } 200.0 \text{ keV} \leq E \leq 20.0 \text{ MeV} \\ 7.29 \times 10^{-4} \left(\frac{E}{\text{MeV}}\right)^{-2.0} & \text{if } E \geq 20.0 \text{ MeV} \end{cases}$$



## 2. Cosmic Diffused Gamma-Ray Background (CDGRB)

$$\frac{dN}{dE} = \begin{cases} 7.877 E^{-1.29} \exp^{-E/41.13} & \text{if } E \leq 60.0 \text{ keV} \\ 4.32 \times 10^{-4} \left(\frac{E}{60}\right)^{-6.5} + 8.4 \times 10^{-3} \left(\frac{E}{60}\right)^{-2.58} & \\ + 4.8 \times 10^{-4} \left(\frac{E}{60}\right)^{-2.05} & \text{if } E \geq 60.0 \text{ keV} \end{cases}$$

# MeGaT design

$$\cos \varphi = 1 - m_e c^2 \left( \frac{1}{E_\gamma} - \frac{1}{E_\gamma + K_e} \right)$$

$$ARM = \sqrt{\sigma_{\varphi_{geo}}^2 + \sigma_{\varphi_{recon}}^2}$$

$$\sigma_\varphi^2 = \left( \frac{\partial \varphi}{\partial K_e} \right)^2 \sigma_e^2 + \left( \frac{\partial \varphi}{\partial E_\gamma} \right)^2 \sigma_\gamma^2$$

$$\frac{\partial \varphi}{\partial K_e} = \frac{m_e c^2}{\sin \varphi} \cdot \frac{1}{(E_\gamma + K_e)^2}$$

$$\frac{\partial \varphi}{\partial E_\gamma} = -\frac{m_e c^2}{\sin \varphi} \cdot \left[ \frac{1}{E_\gamma^2} - \frac{1}{(E_\gamma + K_e)^2} \right]$$

